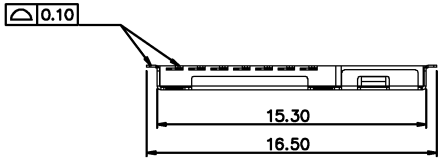
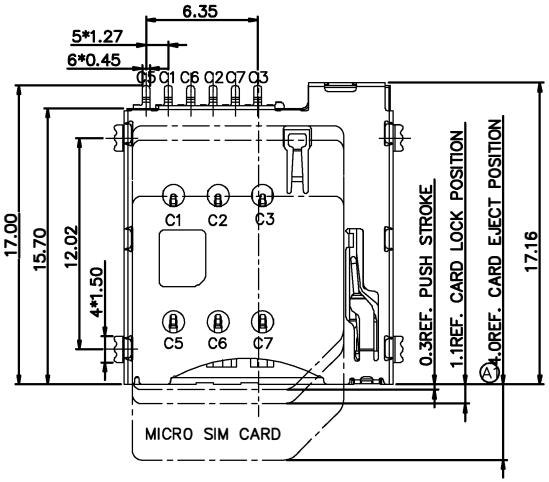
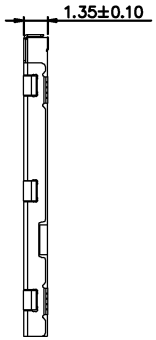
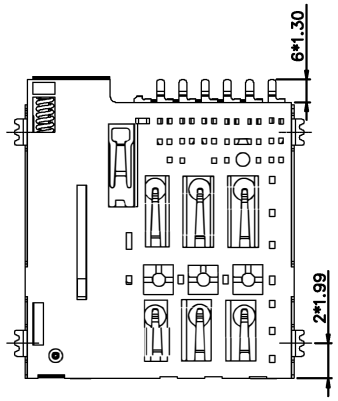
REV	DATE	ECN NO.	MODIFICATION	APPROVER
A	2016/10/14		NEW	Jason_Lee
A1	2017/05/15	RD00317051501	SIZE CHANGE	Jason_Lee

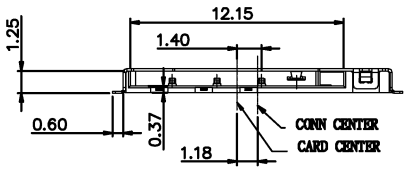




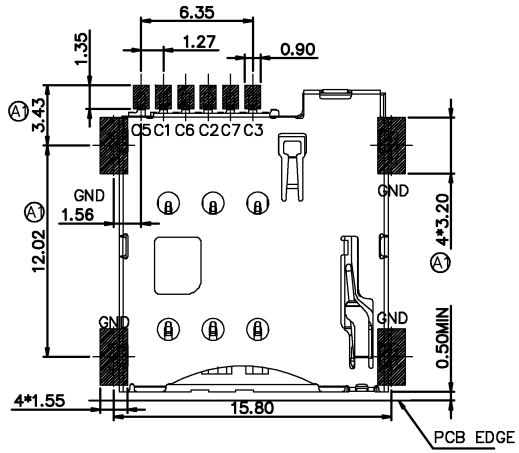




NOTES:
MATERIAL:
Housing: High Temperature thermoplastic,UL94V-0
Terminal: Copper Alloy
Shell: Stainless
SPECIALITY:
Rated Current: 0.5A MAX
Rated Voltage: 50V
Ambient Temperature Range: -40℃~+85℃
Ambient Humidity Range : 95% R.H. Max.
Contact Resistance: 100mΩ Max
Insulation Resistance: 1000MΩ/250V DC
Dielectric Withstanding Voltage: 500V AC
Durability: 5000 cycles
Temperature 260±5℃,



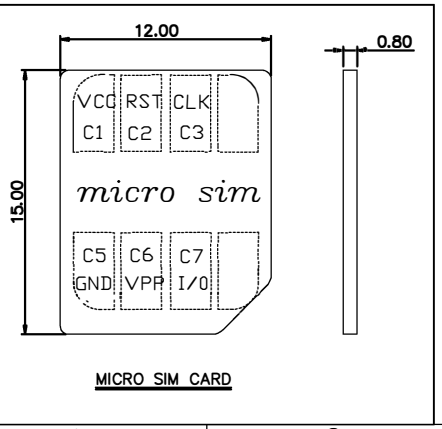
IM pin Assignment	
IN#	Name
C1	VCC
C2	RST
C3	CLK
C5	GND
C6	VPP
C7	I/O



SMT SOLDER AREA
THERE SHOULD NOT BE ANY CIRCUITRIES
IN THE LAYOUT SPACE OF THE PRODUCTS

RECOMMENDED PCB LAYOUT

GENERAL TOLERANCE±0.05



GENERAL TOLERANCE			
SELECT			✓
TOL. ON.	1	2	3
X.XXX	±0.10	±0.05	±0.15
X.XX	±0.15	±0.13	±0.25
X.X	±0.20	±0.25	±0.5
X.	±0.30	±0.38	±1.00
ANGLE	±2°		

UNITS mm
MAT'L
FINISH
Q'TY

NAME: MICRO SIM CARD 6P PUSH PUSH
PART NO: MO4-0103540ROA
APPD:
CHKD:
DR: JACK

ABOOSTY 爱比速 深圳市摩天射频技术有限公司 ShenZhen MyAntenna RF Technology Co.,Ltd

TITLE: MICRO SIM CARD 6P PUSH PUSH SMT H=1.35mm 不带检测脚 无柱

A-MicroSIM-1.35A

SCALE	SHEET	REV
1:1	1/1	A1